

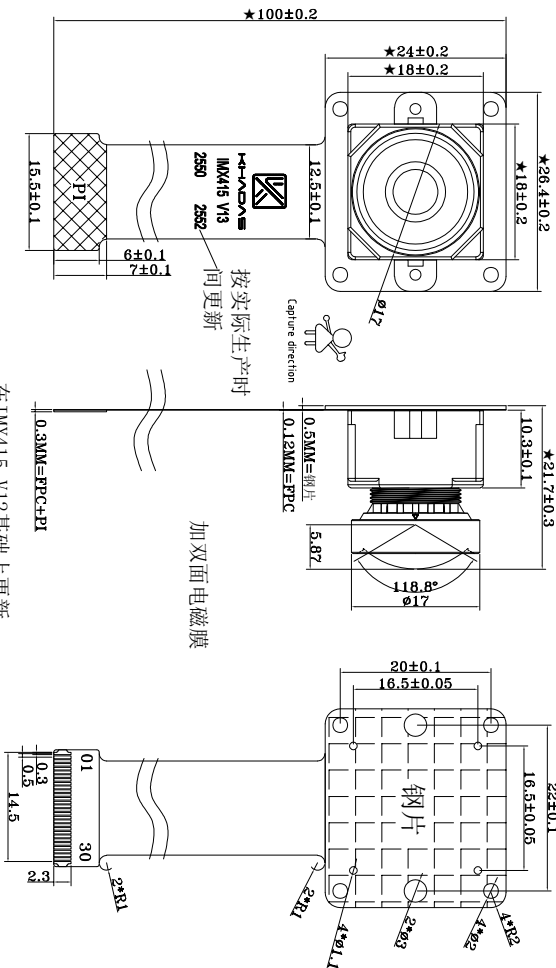
REV.	DESIGN NO.	LOCATION	DESIGN CHANGE DESCRIPTION	DATE	SIGN
V13	-	-	Initial issue	2025/12/08	XL ZOU

NO.	SYMBOL
1	GND
2	D9N
3	D9P
4	GND
5	D2N
6	D2P
7	GND
8	NC
9	NC
10	GND
11	D1N
12	D1P
13	GND
14	D0N
15	D0P
16	GND
17	CLKN
18	CLKP
19	NC
20	MCLK
21	RST
22	SCL
23	SDA
24	NC
25	1.9V
26	GND
27	GND
28	3V3
29	3V3
30	3V3

封装 (Enc Size)	1/2-BINCH
封装 (FD)	2.02MM
引脚 (FMD)	2.4
封装角 (View Angle)	D:118.8° H:109.9° V:74.8°
封装 (Distortion)	<-3.6%
封装 (Flip Type)	IMX415
封装 (Array Size)	3840*2160
封装 (VDD)	1.1V
封装 (VDD)	1.8V
封装 (VDD)	2.9V

红色网络阻抗100欧姆

在IMX415 V12基础上更新
马达驱动IC, 更新丝印



GENERAL TOLERANCE		SIGN	DATE	MATERIAL		PART NAME	
X ±0.5	X *±2.0	DESIGN	XL ZOU	2025/12/08	REV. V13	SCALE 1:1	PROCESS CNC
X ±0.25	X *±1.5	APPROVAL			REV. V13	SCALE 1:1	PROCESS CNC
XX ±0.10	XX *±0.5	THIRD ANGLE			PAGE 1 OF 1	UNIT mm	PROCESS KHADAS TECHNOLOGY CO., LTD.

